

**S-NAUBA 5021** 

Wax Alloy Powder

Shamrock's product line of micronized waxes provide rub and abrasion resistance. Included in this line are products that provide gloss, matting, clarity, and controlled slip in a range of particle sizes.

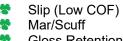
## **Product Description:**

S-NAUBA 5021 is a concentrated blend of carnauba and synthetic wax showing melting peaks ranging from  $84 - 110^{\circ}$ C.

### **Application:**

S-NAUBA 5021 is used in both the ink and coating industry at a recommended level of 0.5-3.0%. S- NAUBA 5021 is recommended for both paste inks and powder coatings in all aqueous/solvent based systems.

#### **Features and Benefits:**



Gloss Retention

### **Typical Properties:**

*	Specific Gravity: Particle Size Mean Value: NPIRI Grind: Hegman Grind:	1.0 g/cm <sup>3</sup> 7 μm 5.0 Max 6.5 Min	
	Hegman Grind:	6.5 MIN	

# **Regulatory Status:**

The components of this product are listed on multiple chemical inventories. For specific information on the applicable chemical inventories, please refer to the product SDS.

#### Safety, Shipping and Handling:

For complete safety, shipping and handling information please contact your regional Customer Service Representative, or our Customer Service Team at customerserviceteam@shamrocktechnologies.com.

For **more** information about Shamrock's other products or capabilities please visit us at our website, ShamrockTechnologies.com.

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